



**Pb-free
HEAT**



U□1112H Series

Single Color Ultra High Brightness Type

Features

Package	2125(h =0.8mm) Type, Milky White resin
Product features	• Outer Dimension 2.0 x 1.25 x 0.8mm (L x W x H) • Temperature range Storage Temperature : -40 ~ 100 Operating Temperature : -40 ~ 85 • No lead package and lead-free soldering compatible
Dominant wavelength	Blue : 470nm(UB) Blue Green : 508nm(UC) Green : 530nm(UG) Yellow : 590nm(UY) Red : 630nm(UR)
Half Intensity Angle	UB,UC,UG : $\theta x = 140 \text{ deg.}, \theta y = 165 \text{ deg.}$ UY,UR : $\theta x = 150 \text{ deg.}, \theta y = 140 \text{ deg.}$
Die materials	UB,UC,UG : InGaN, UY,UR : AlGaInP
Rank grouping parameter	Sorted by luminous intensity and wavelength per rank taping
Assembly method	Auto pick & place machine (Auto Mounter)
Soldering methods	Reflow soldering, TTW (Through The Wave) soldering and manual soldering
Taping and reel	4,000pcs per reel in a 8mm width tape. (Standard) Reel diameter: $\phi 180\text{mm}$
ESD	1kV (HBM)

Recommended Applications

Communication Machine, Electric Household Appliances, OA/FA, Other General Applications

Color and Luminous Intensity

(Ta=25°C)

Part No.	Material	Emitted Color	Lens Color	Dominant Wavelength λ_d (nm)		Luminous Intensity I_v (mcd)		
				TYP.	I_F	MIN.	TYP.	I_F
UB1112H	InGaN	Blue	Milky White	470	10	17	34	10
UC1112H	InGaN	Blue Green		508	10	80	160	10
UG1112H	InGaN	Green		530	10	96	160	10
UY1112H	AlGaInP	Yellow		590	20	50	100	20
UR1112H	AlGaInP	Red		630	20	50	100	20

Absolute Maximum Ratings

(Ta=25°C)

Item	Symbol	Absolute Maximum Ratings					Unit
		UB	UC	UG	UY	UR	
Power Dissipation	P _d	78	78	78	87	87	mW
Forward Current	I _F	20	20	20	30	30	mA
Pulse Forward Current ※1	I _{FRM}	48	48	48	100	100	mA
Derating (Ta=25°C or higher)	I _F	0.28	0.28	0.28	0.43	0.43	mA/
	I _{FRM}	0.69	0.69	0.69	1	1	mA/
Reverse Voltage	V _R	5	5	5	5	5	V
Operating Temperature	T _{opr}	-40~+85					
Storage Temperature	T _{stg}	-40~+100					

 ※1 I_{FRM} Measurement condition :tw≤1ms., Duty≤1/20 (UY,UR : ≤1/10).

Electro-Optical Characteristics(UB,UC,UG)

(Ta=25°C)

Item	Conditions	Symbol	Characteristics				Unit
				UB	UC	UG	
Forward Voltage	I _F =10mA	V _F	TYP.	3.4	3.4	3.4	V
			MAX.	3.9	3.9	3.9	
Reverse Current	V _R =5V	I _R	MAX.	100	100	100	μ A
Peak Wavelength	I _F =10mA	λ _p	TYP.	465	502	522	nm
Dominant Wavelength	I _F =10mA	λ _d	TYP.	470	508	530	nm
Spectral Line Half Width	I _F =10mA	λ	TYP.	26	30	35	nm
Half Intensity Angle	I _F =10mA	2 θ 1/2	TYP.	140(θ x)	140(θ x)	140(θ x)	deg.
				165(θ y)	165(θ y)	165(θ y)	

Electro-Optical Characteristics(UY,UR)

(Ta=25°C)

Item		Symbol	Characteristics			Unit
	Conditions			UY	UR	
Forward Voltage	I _F =20mA	V _F	TYP.	2.2	2.2	V
			MAX.	2.8	2.8	
Reverse Current	V _R =5V	I _R	MAX.	100	100	μ A
Peak Wavelength	I _F =20mA	λ _p	TYP.	592	641	nm
Dominant Wavelength	I _F =20mA	λ _d	TYP.	590	630	nm
Spectral Line Half Width	I _F =20mA	λ	TYP.	18	18	nm
Half Intensity Angle	I _F =20mA	2 θ 1/2	TYP.	150(θ x)	150(θ x)	deg.
				140(θ y)	140(θ y)	

Luminous Intensity Rank

(Ta=25°C)

Rank	I _V (mcd)									
	UB		UC		UG		UY		UR	
	I _F =10mA		I _F =10mA		I _F =10mA		I _F =20mA		I _F =20mA	
	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.
A			80	112			50	100	50	100
B			96	136			70	140	70	140
C			112	160	96	136	100	200	100	200
D	17	24	136	192	112	160	140	280	140	280
E	20	28	160	224	136	192	200	400	200	400
F	24	34	192	320	160	224	280	-	280	-
G	28	40	224	-	192	272				
H	34	48			224	320				
J	40	56			272	-				
K	48	-								

Please contact our sales staff concerning rank designation.

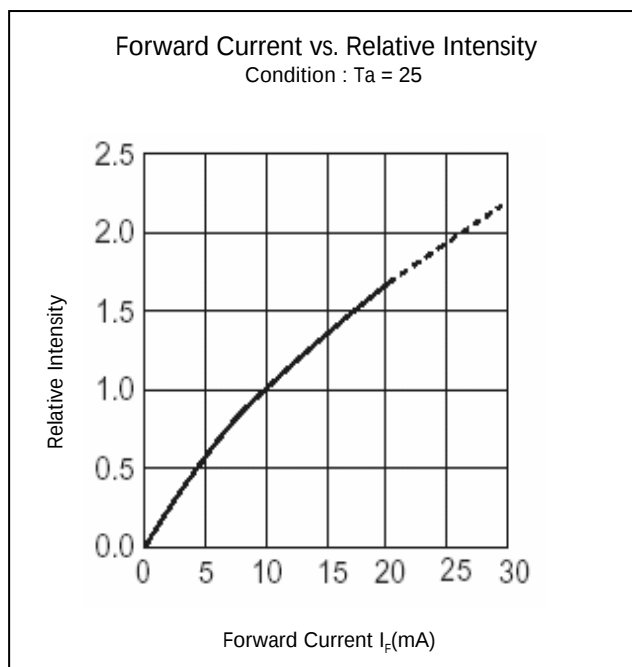
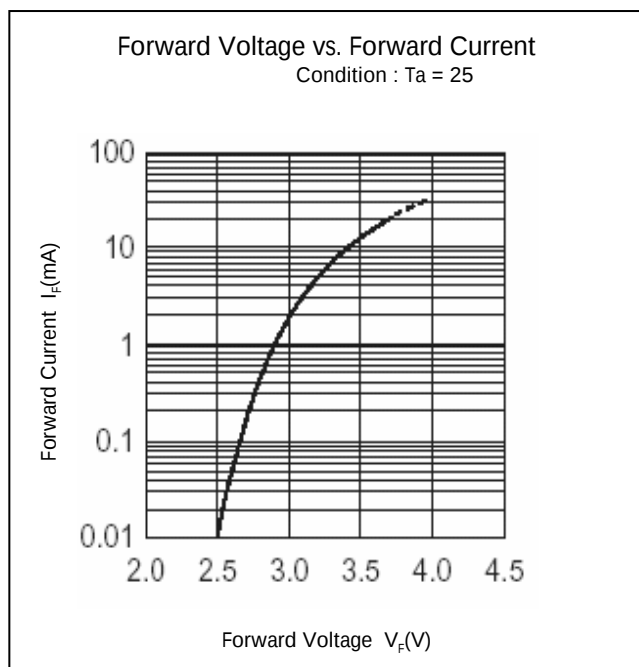
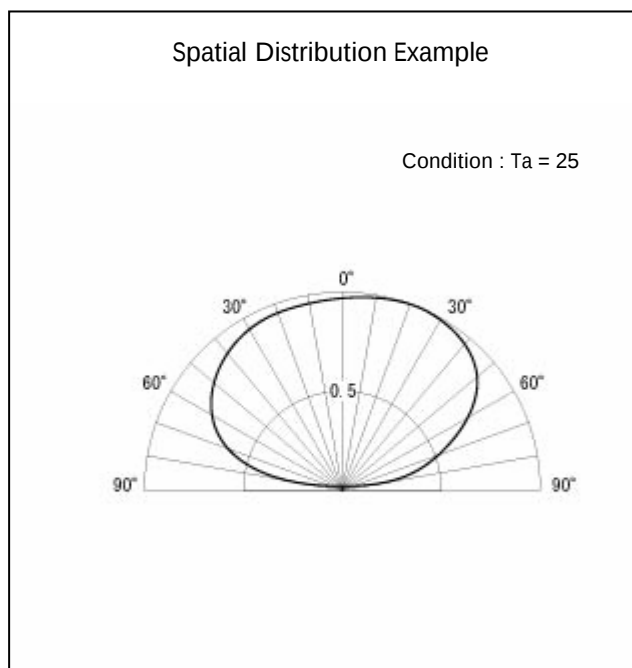
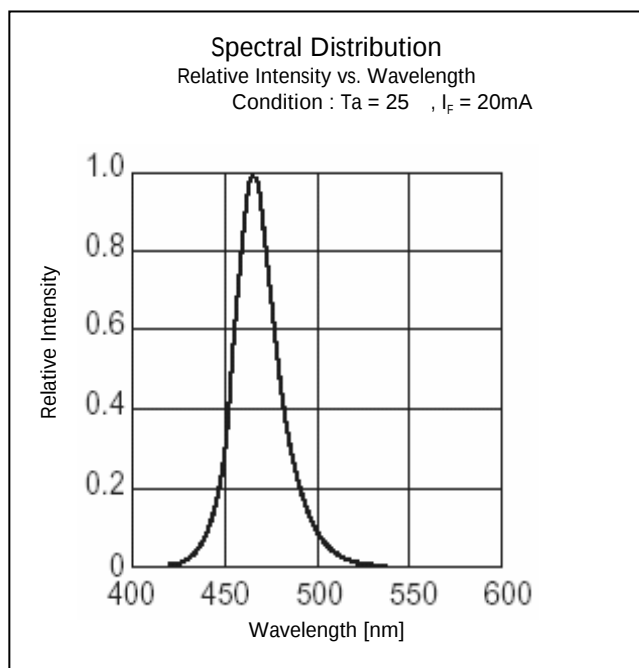
Color Tone Groups (λ d)

(Ta=25°C)

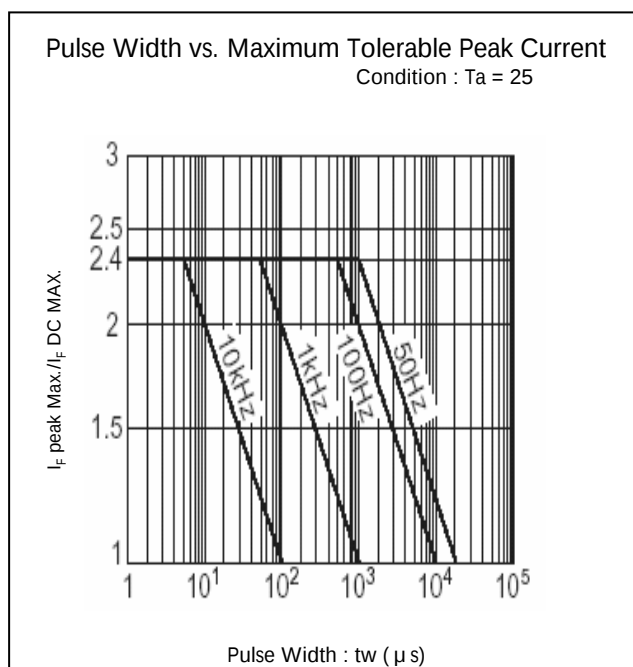
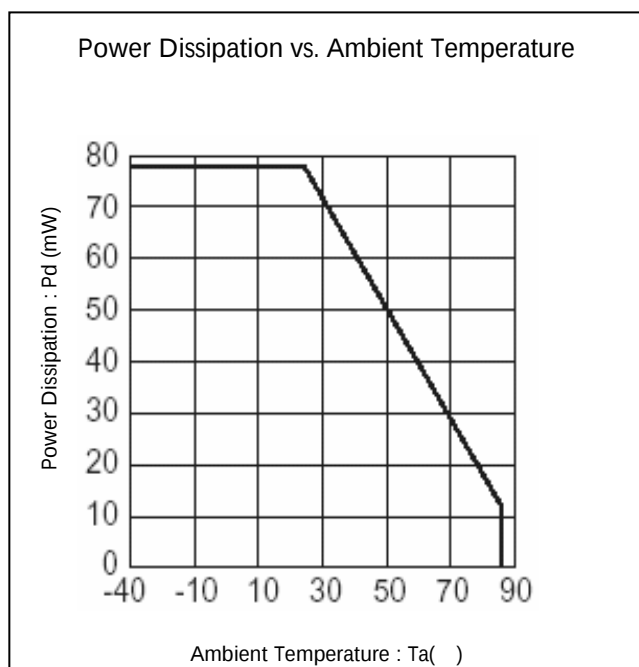
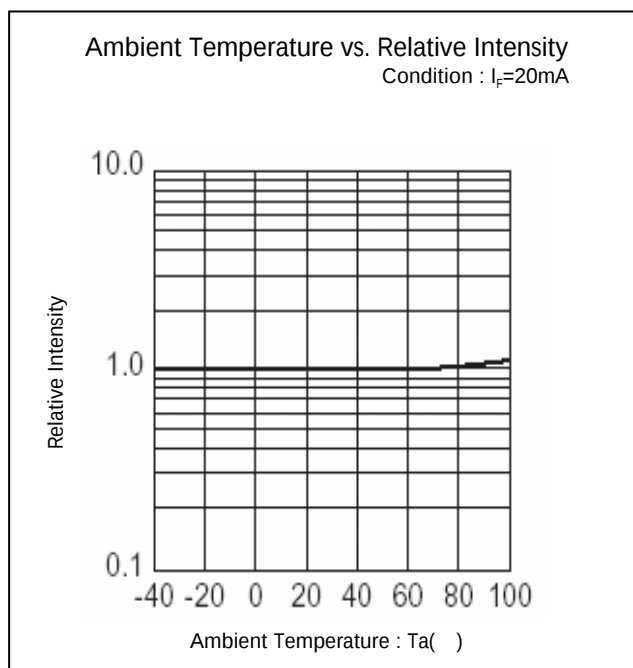
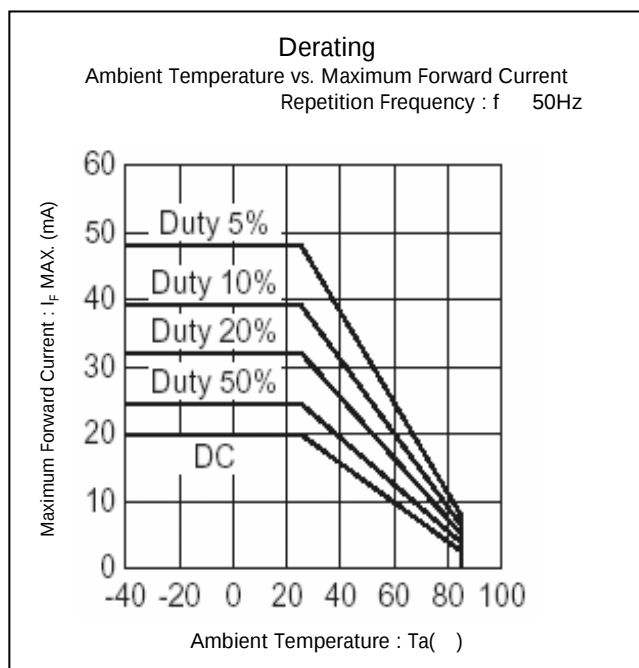
Rank	Dominant Wavelength λ d (nm)			
	UY		UR	
	I _F =20mA		I _F =20mA	
	MIN.	MAX.	MIN.	MAX.
A	580	585	620	630
B	584	589	628	638
C	588	593		
D	592	597		
E	596	601		

Please contact our sales staff concerning rank designation.

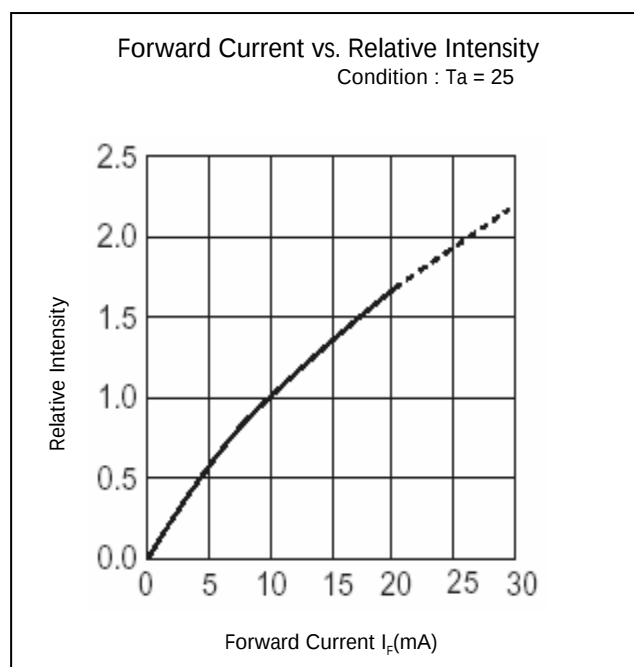
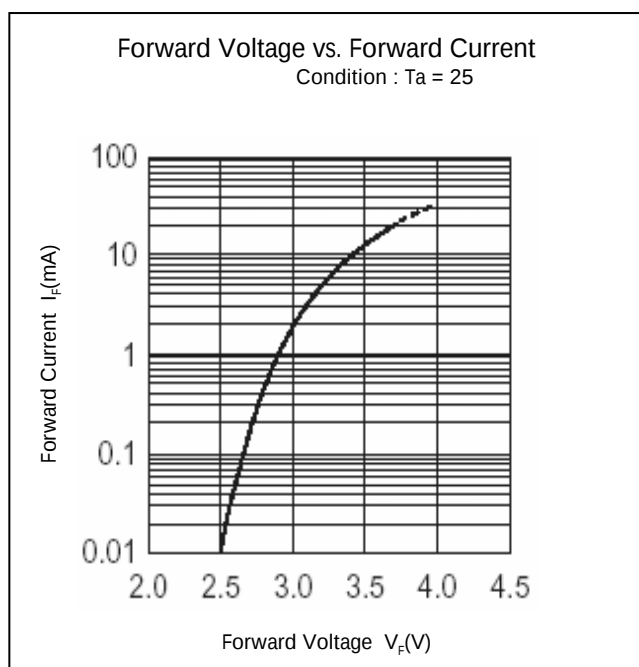
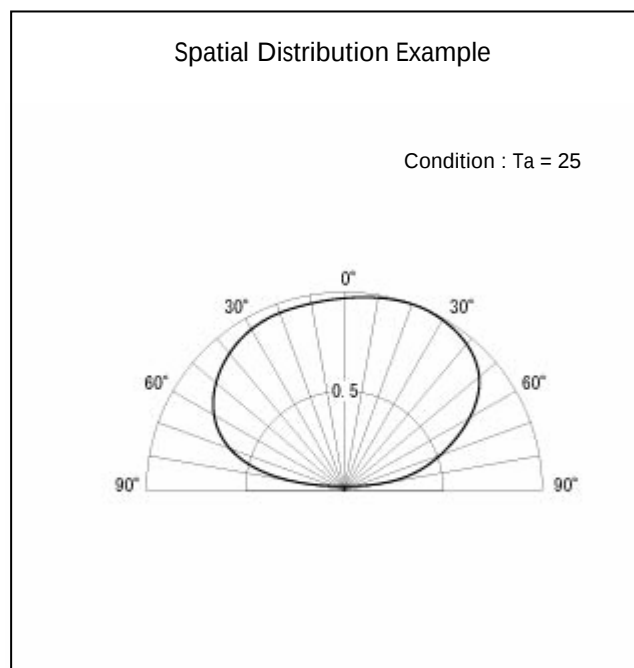
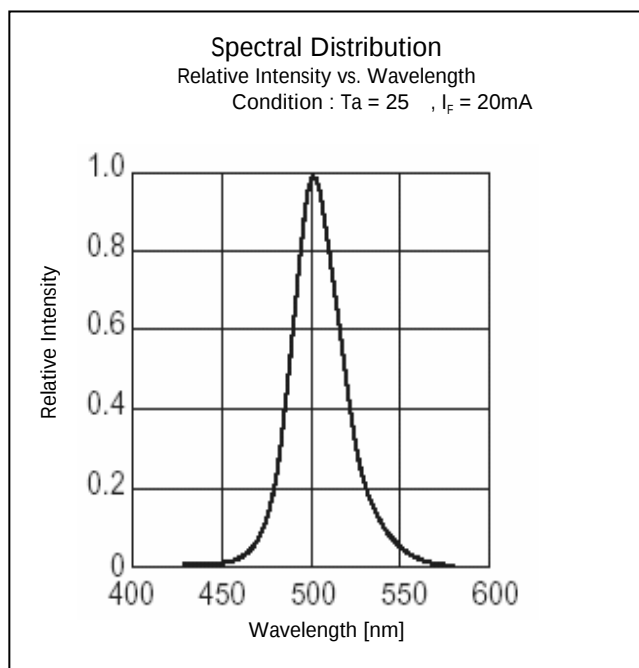
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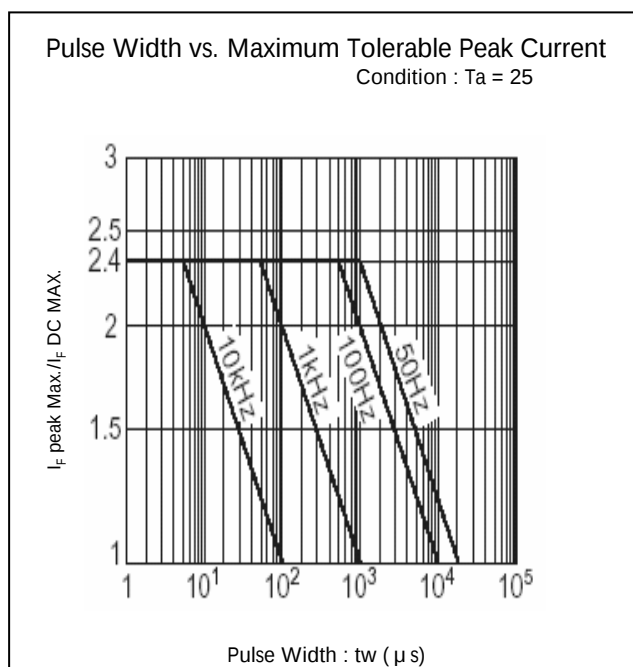
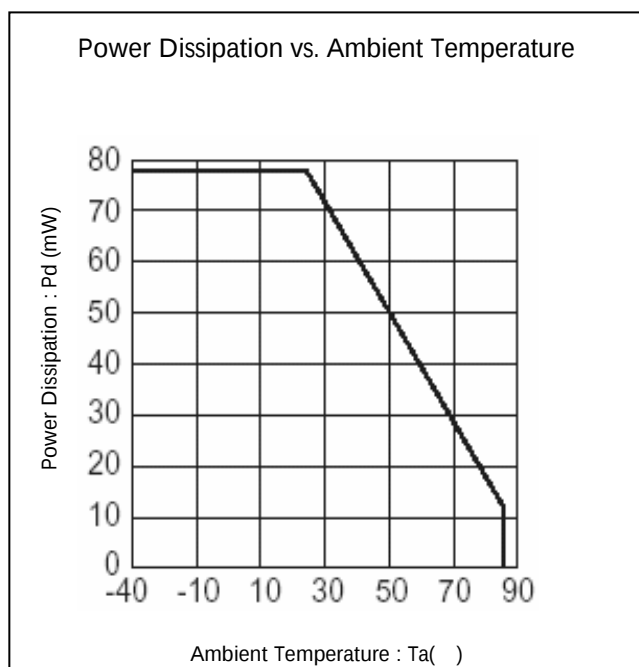
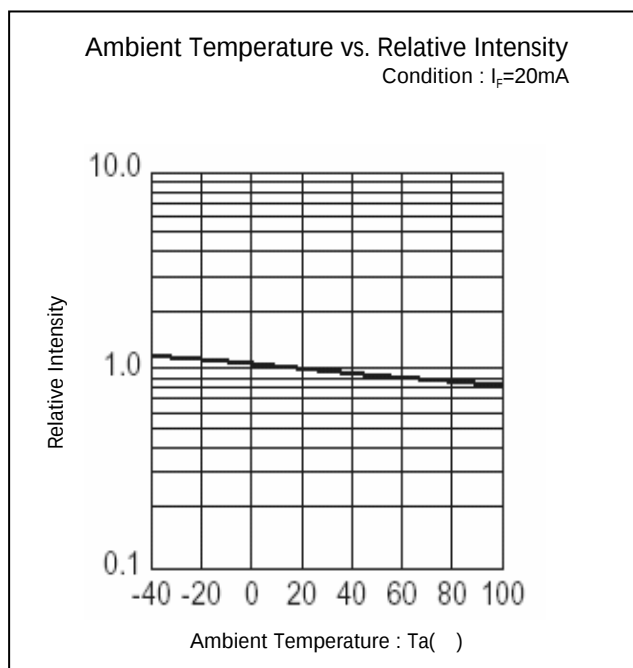
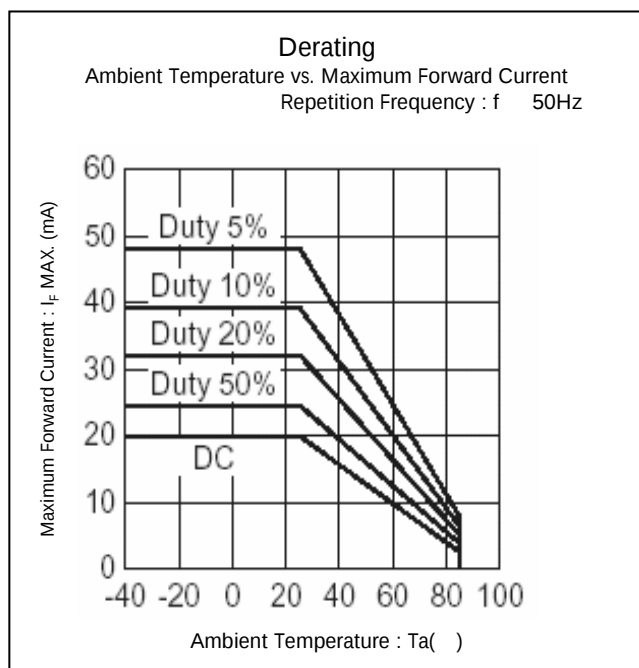
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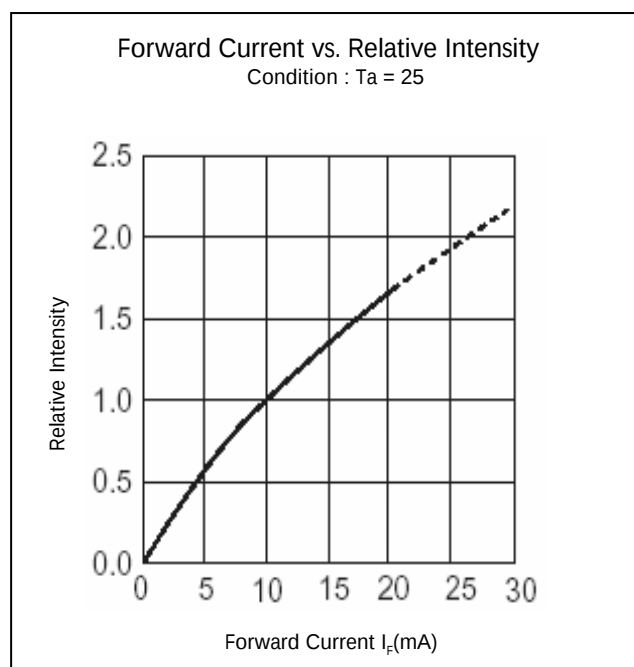
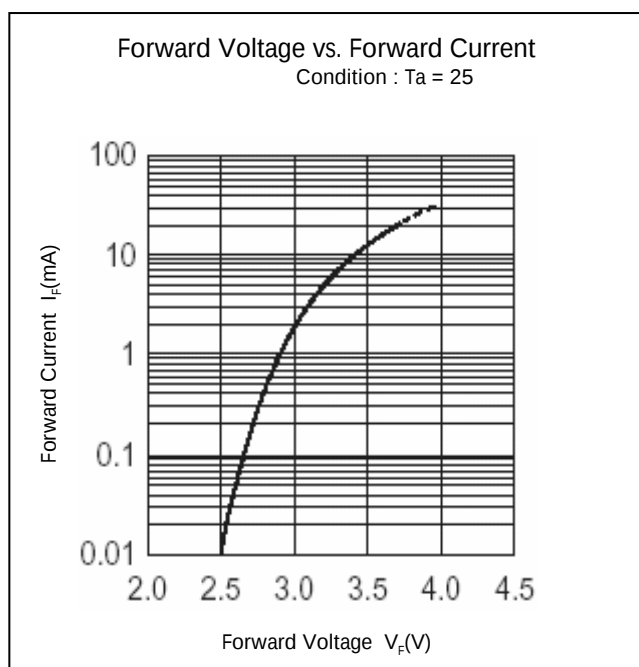
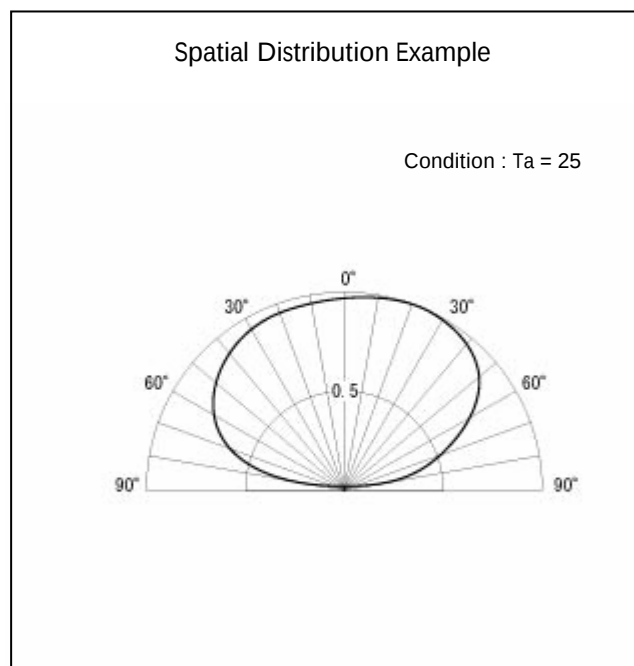
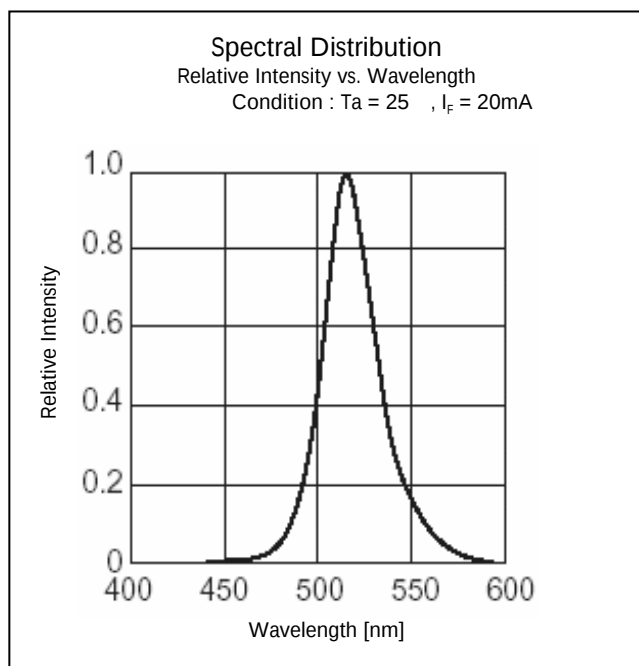
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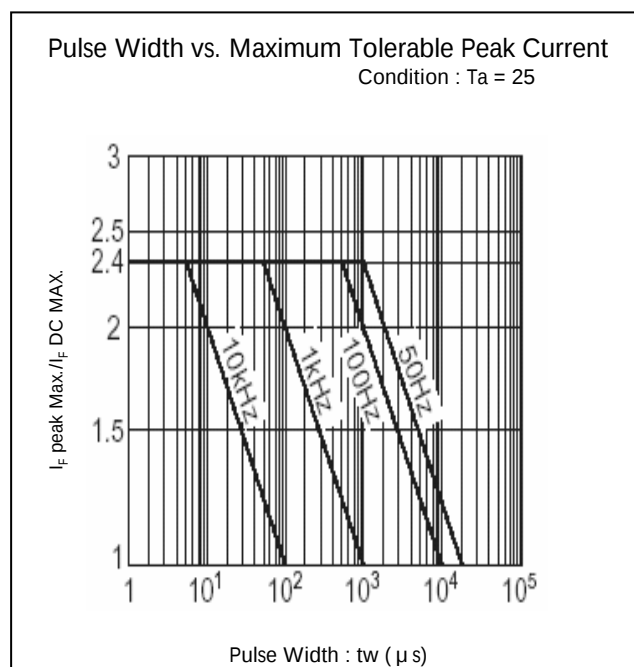
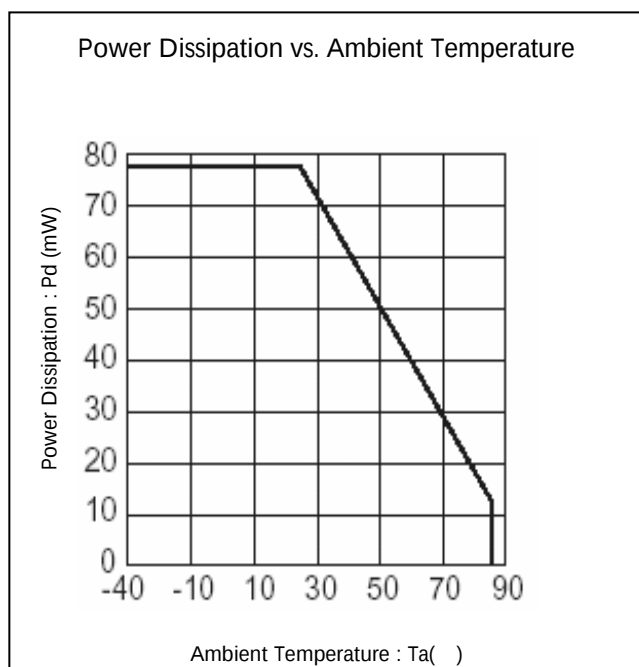
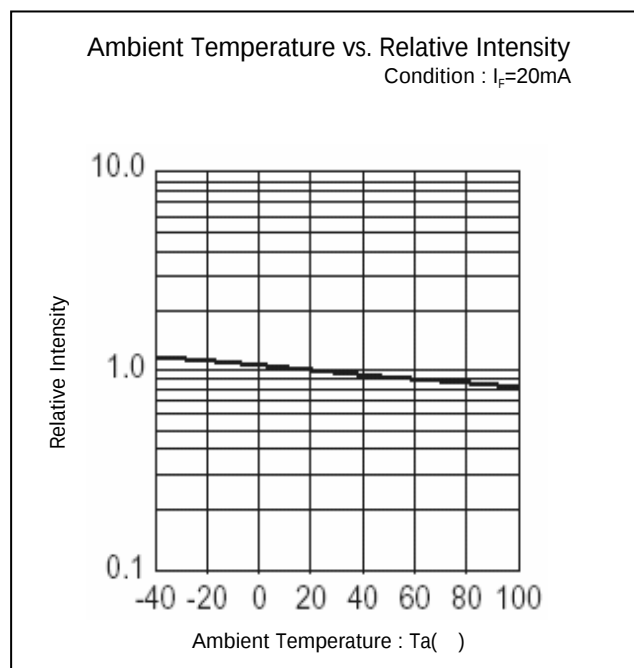
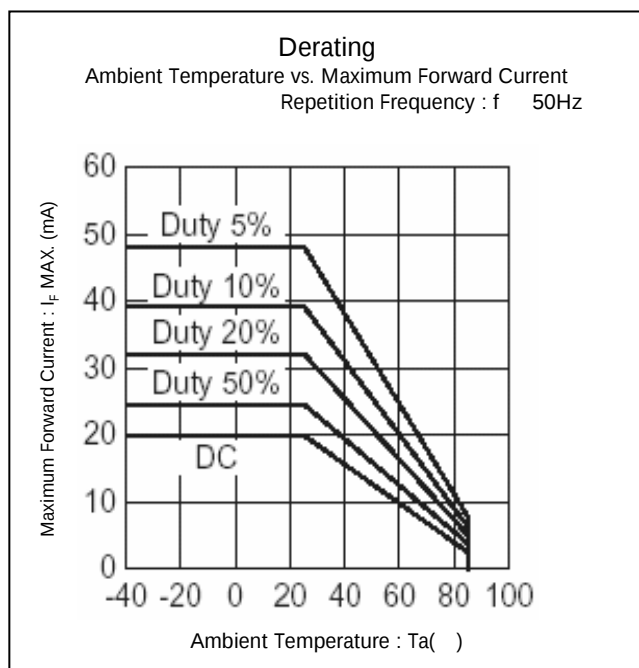
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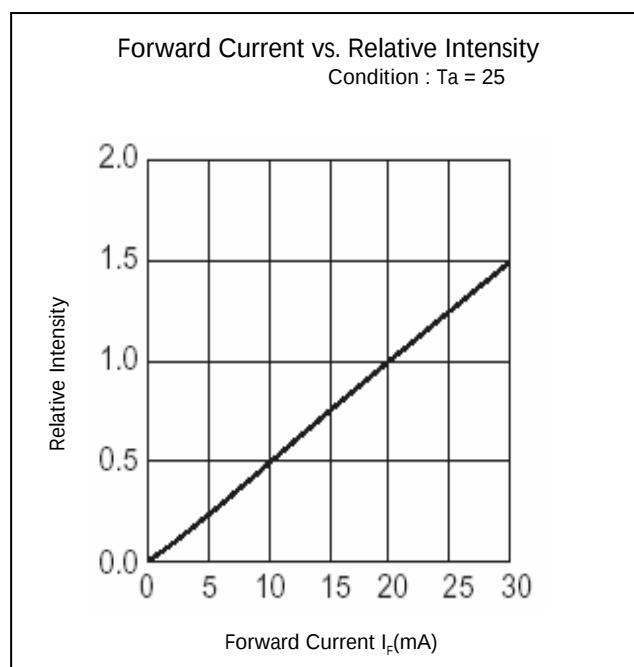
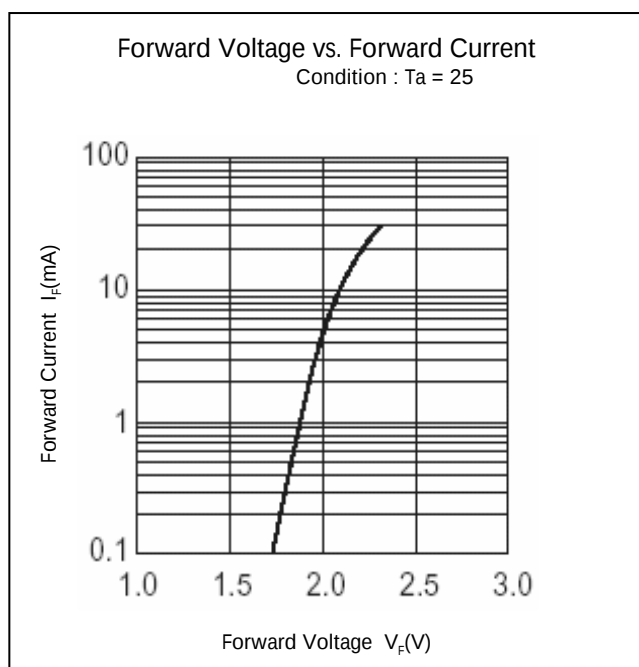
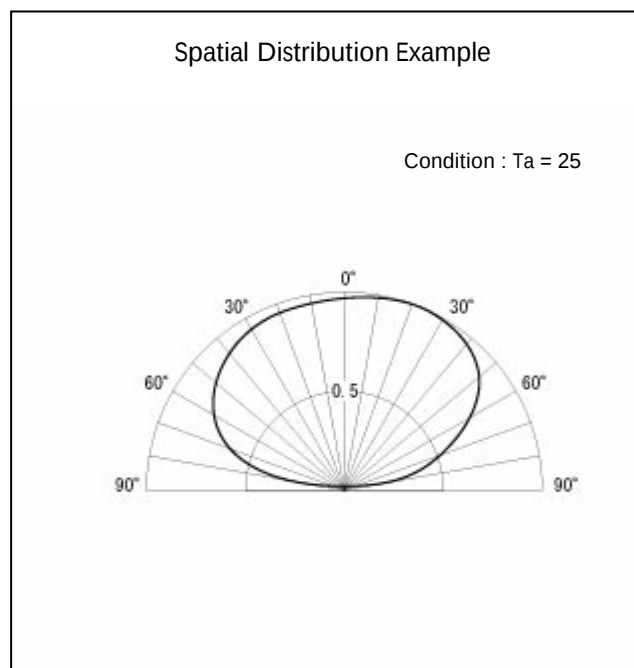
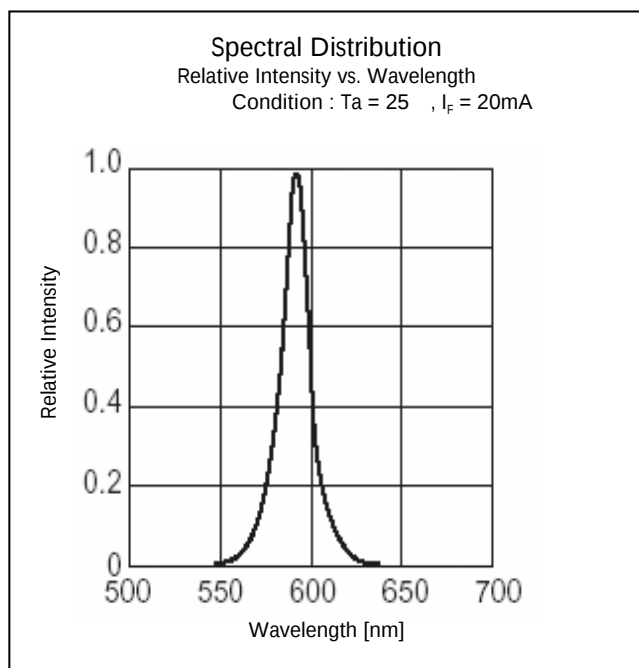
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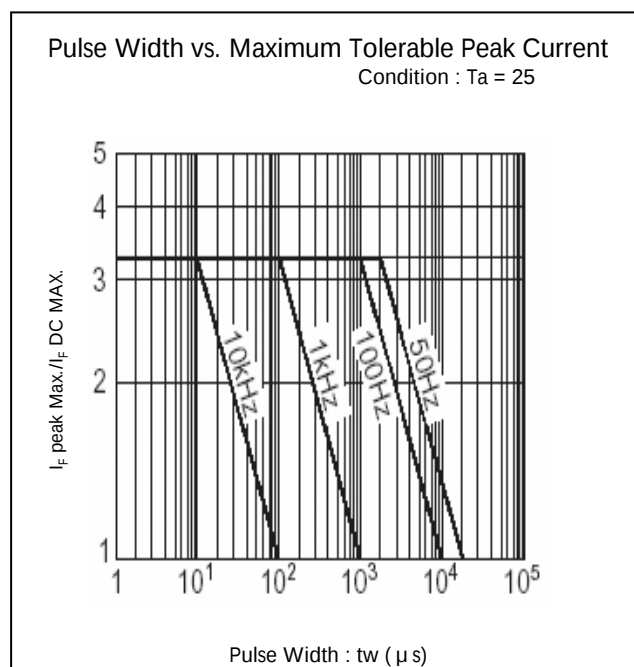
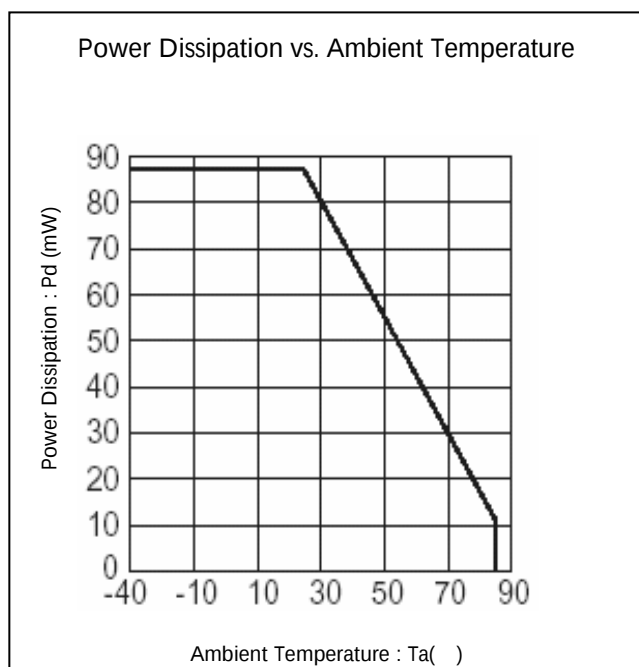
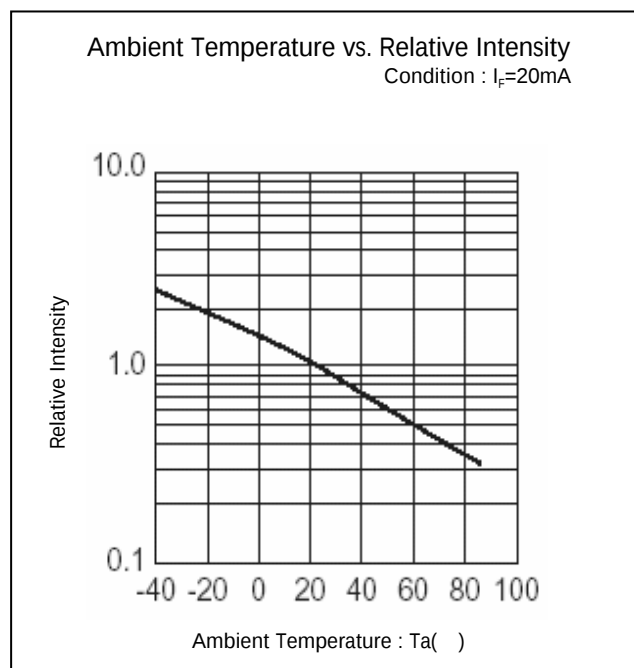
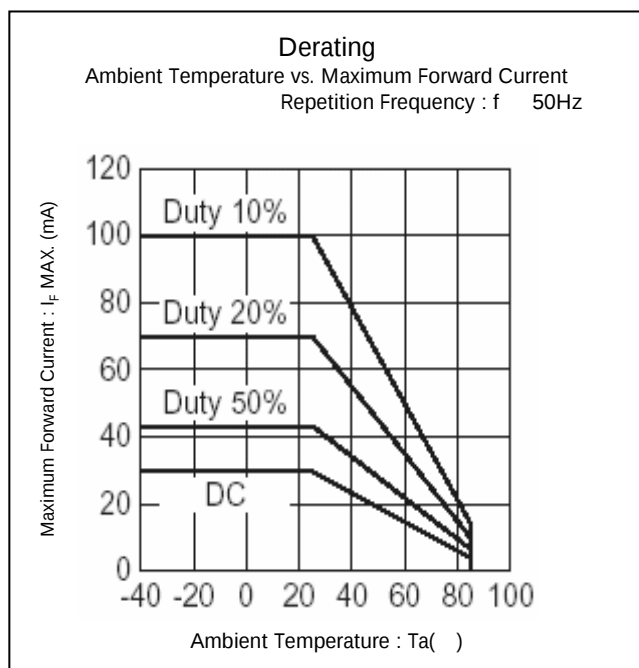
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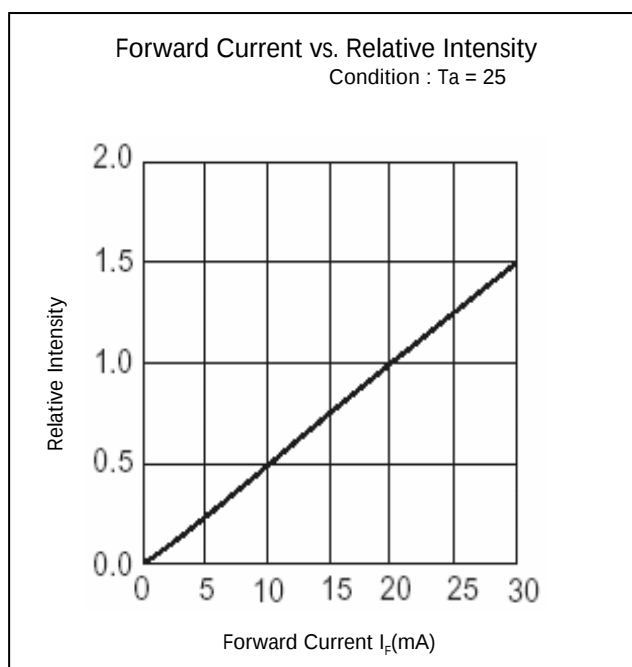
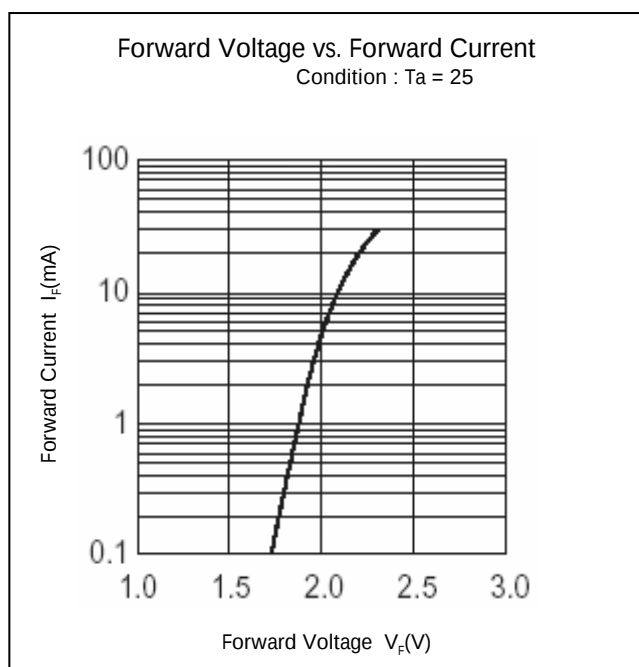
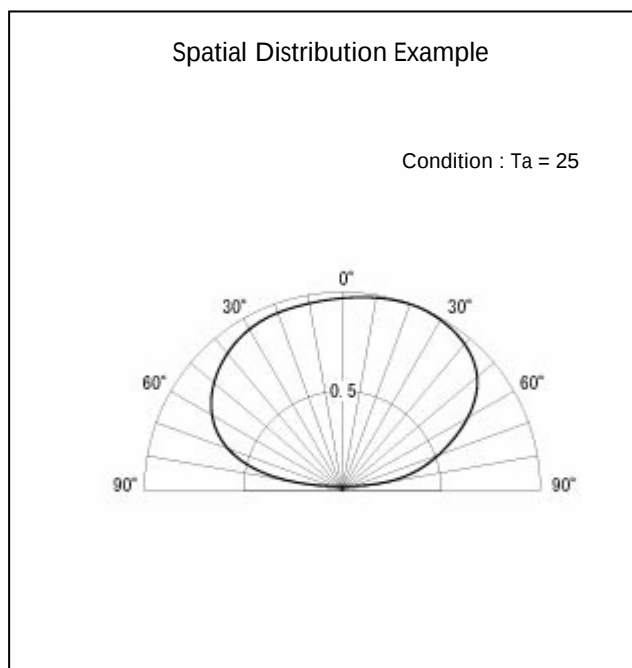
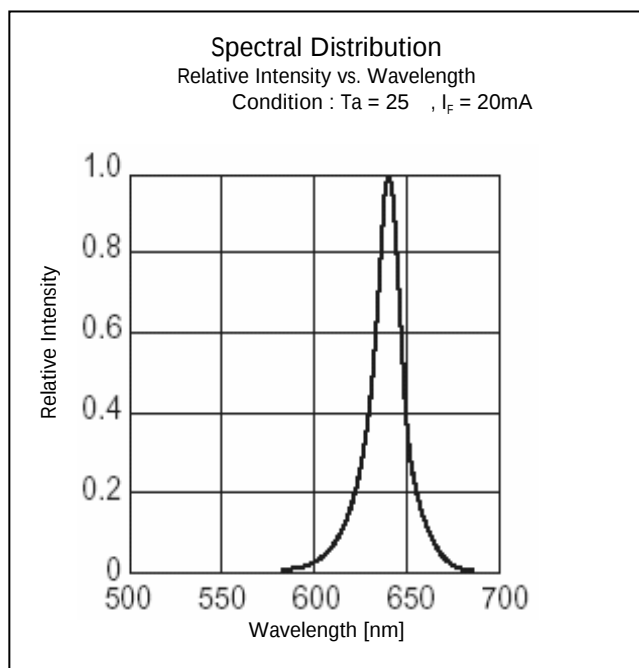
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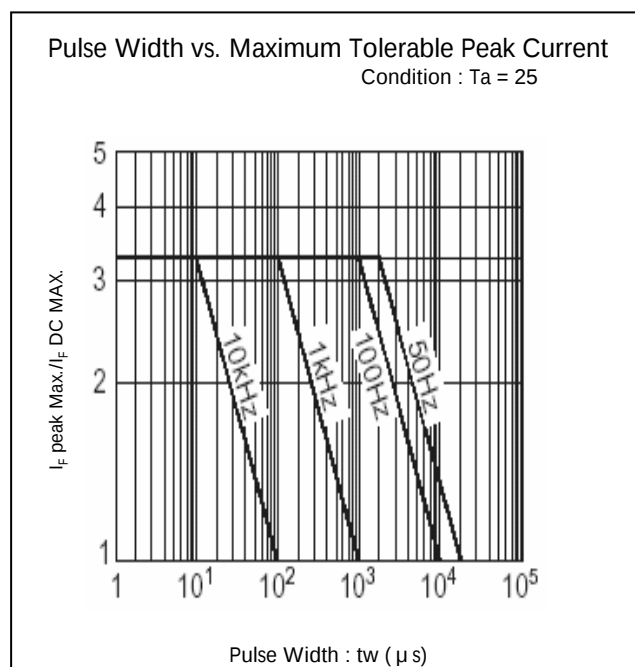
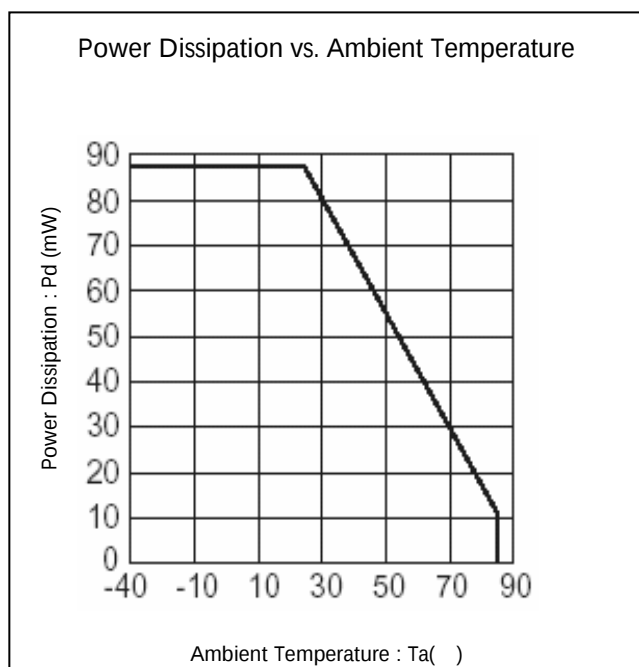
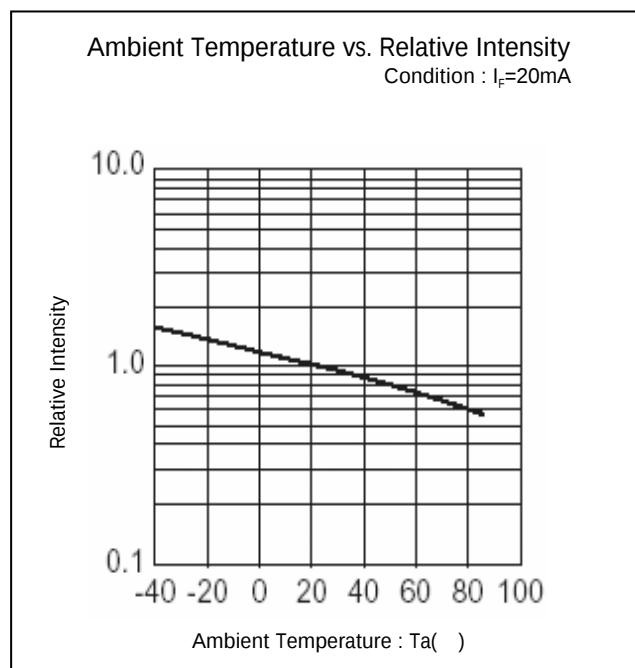
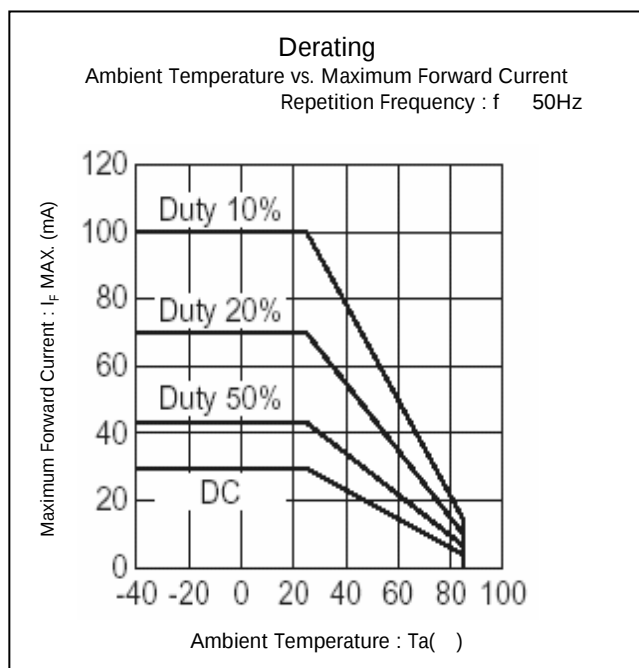
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Technical Data(UR)



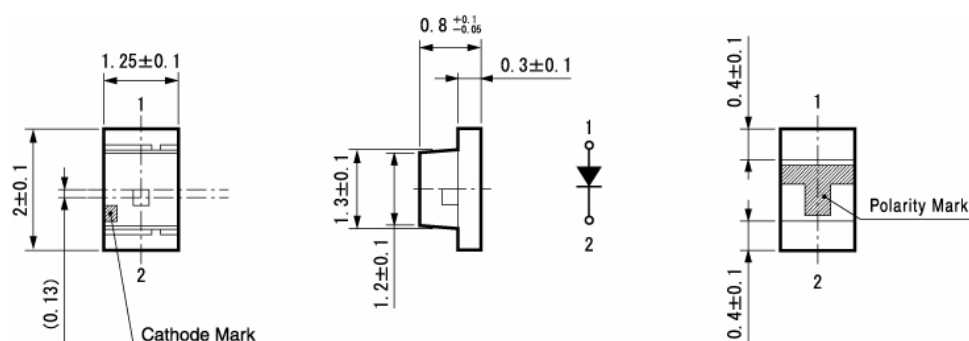
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Package Dimensions

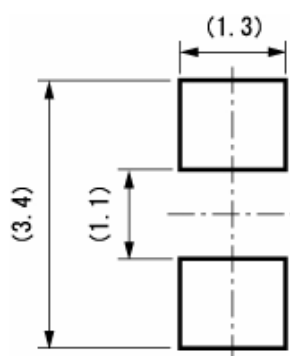
(Unit: mm)

Weight: (2.84)mg



Recommended Soldering Pattern

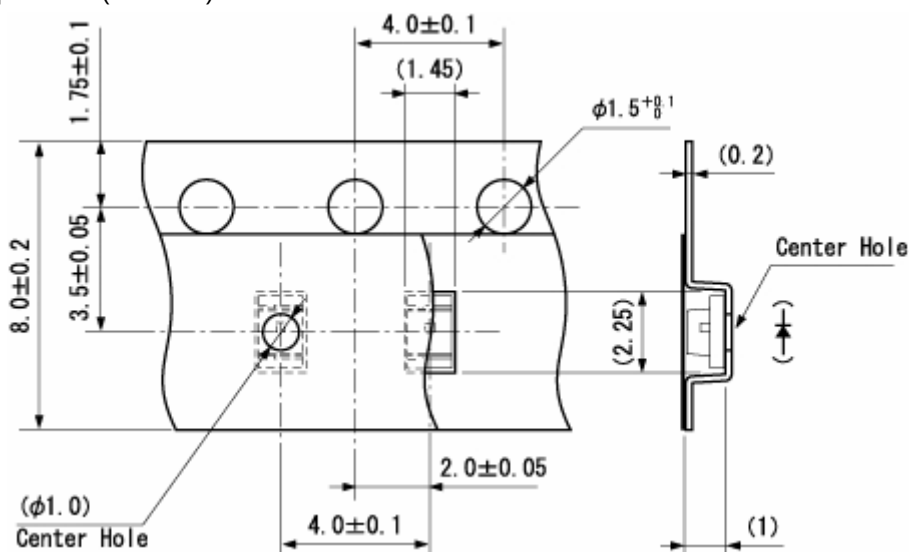
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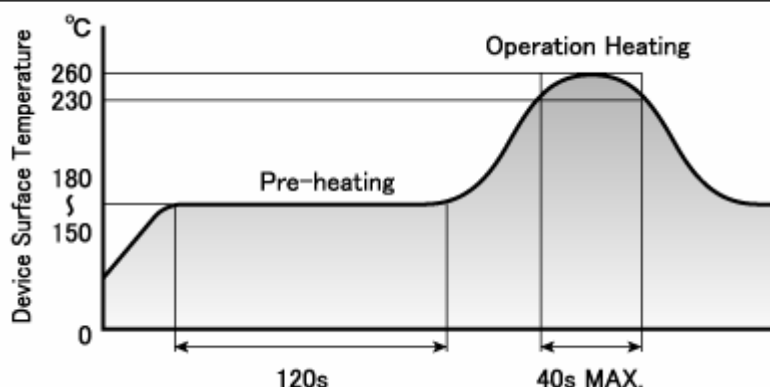
Taping Specification

(Unit: mm)

Quantity : 4,000pcs/ reel (standard)



Reflow Soldering Conditions



- 1) The above profile temperature gives the maximum temperature of the LED resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the LED from absorbing moisture.
- 3) Temperature fluctuation to the LED during the pre-heating process shall be minimized. (6 maximum)

TTW (Through The Wave) soldering Conditions

Pre-heating	120 60 s	(MAX.) (MAX.)
Solder Bath Temp.	265	(MAX.)
Dipping Time	5 s	(MAX.)

- 1) The dip soldering process shall be 2 times maximum.
- 2) The product shall be cooled to normal temperature before the second dipping process.

Manual Soldering Conditions

Iron tip temp.	350	(MAX.)
Soldering time and frequency	3 s 1 time	(MAX.) (MAX.)

Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED-4701/100(101)	Ta = 25°C, If = Maximum Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED-4701/300(302)	260±5°C	5sec	0/25
Temperature Cycling	EIAJ ED-4701/100(105)	Minimum Rated Storage Temperature(30min) ~Normal Temperature(15min) ~Maximum Rated Storage Temperature(30min) ~Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED-4701/100(103)	Ta = 60±2°C, RH = 90±5%	1,000 h	0/25
High Temp. Storage Life	EIAJ ED-4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED-4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Vibration, Variable Frequency	EIAJ ED-4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous Intensity	Iv	If Value of each product Luminous Intensity	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	V _F	If Value of each product Forward Voltage	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse Current	I _R	V _R = Maximum Rated Reverse Voltage V	Testing Max. Value ≥ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	No notable, decoloration, deformation and cracking

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